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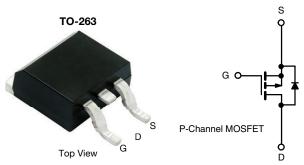
SUM110P06-07L



Vishay Siliconix

P-Channel 60 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	V _{DS} (V) R _{DS(on)} (Ω)			
-60	0.0069 at V _{GS} = -10 V	-110		
	0.0088 at V _{GS} = -4.5 V	-110		



FEATURES

- TrenchFET[®] power MOSFET
- Package with low thermal resistance
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



Ordering Information:

SUM110P06-07L-E3 (Lead (Pb)-free)

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \degree C$, unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage	V _{DS}	-60	V			
Gate-Source Voltage	V _{GS}	± 20	V			
Continuous Drain Current ^d	T _C = 25 °C		-110			
(T _J = 175 °C)	T _C = 125 °C	I _D	-95			
Pulsed Drain Current	I _{DM}	-240	A			
Avalanche Current	L = 0.1 mH	I _{AS}	-75			
Single Pulse Avalanche Energy ^a		E _{AS}	281	mJ		
Dewer Dissinction	T _C = 25 °C °	D	375	w		
Power Dissipation	T _A = 25 °C ^b	PD	3.75	vv		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +175	°C		

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	UNIT	
Junction-to-Ambient	PCB mount ^b	R _{thJA}	40	°C/W	
Junction-to-Case		R _{thJC}	0.4	0/11	

Notes

- a. Duty cycle \leq 1 %.
- b. When mounted on 1" square PCB (FR4 material).
- c. See SOA curve for voltage derating.
- d. Limited by package.

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = -250 μA	-60	-	-		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$ -1		-	-3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA	
Zero Gate Voltage Drain Current		$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1		
	I _{DSS}	V_{DS} = -60 V, V_{GS} = 0 V, T_{J} = 125 °C	-	-	-50	μA	
		V_{DS} = -60 V, V_{GS} = 0 V, T_{J} = 175 °C	-	-	-250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = -5 V, V_{GS} = -10 V$	-120	-	-	А	
		$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -30 \text{ A}$	-	0.0055	0.0069	1	
Drain-Source On-State Resistance ^a	Б	V_{GS} = -10 V, I_D = -30 A, T_J = 125 °C	-	-	0.0115	0	
Drain-Source On-State Resistance "	R _{DS(on)}	V_{GS} = -10 V, I_D = -30 A, T_J = 175 °C	-	-	0.0138	Ω	
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -20 \text{ A}$	-	0.0070	0.0088		
Forward Transconductance ^a	9 _{fs}	V _{DS} = -15 V, I _D = -50 A	20	-	-	S	
Dynamic ^b							
Input Capacitance	C _{iss}		-	11 400	-	pF	
Output Capacitance	Coss	V _{GS} = 0 V, V _{DS} = -25 V, f = 1 MHz	-	1200	-		
Reverse Transfer Capacitance	C _{rss}		-	900	-		
Total Gate Charge ^c	Qg		-	230	345		
Gate-Source Charge ^c	Q _{gs}	V_{DS} = -30 V, V_{GS} = -10 V, I_{D} = -110 A	-	50	-	nC	
Gate-Drain Charge ^c	Q _{gd}		-	60	-		
Gate Resistance	Rg	f = 1 MHz	-	3	-	Ω	
Turn-On Delay Time ^c	t _{d(on)}		-	20	30		
Rise Time ^c	t _r	$V_{DD} = -30 \text{ V}, \text{ R}_{\text{L}} = 0.27 \Omega$	-	25	40	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D\cong$ -110 A, V_{GEN} = -10 V, R_g = 1 Ω	-	110	200		
Fall Time ^c	t _f		-	50	100		
Drain-Source Body Diode Character	istics (T _C = 25	ō °C ♭)					
Continuous Current	I _S		-	-	-110	^	
Pulsed Current	I _{SM}		-	-	-240	A	
Forward Voltage ^a	V _{SD}	$I_{F} = -85 \text{ A}, V_{GS} = 0 \text{ V}$	-	-1	-1.5	V	
Reverse Recovery Time	t _{rr}		-	91	137	ns	
Peak Reverse Recovery Charge	I _{RM(REC)}	I _F = -85 A, dl/dt = 100 A/μs	-	-6	-9	А	
Reverse Recovery Charge	Q _{rr}		-	0.21	0.44	μC	

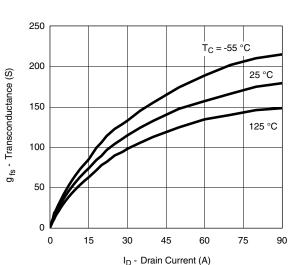
Notes

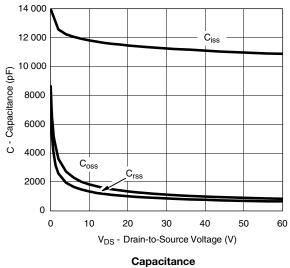
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.







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SUM110P06-07L

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

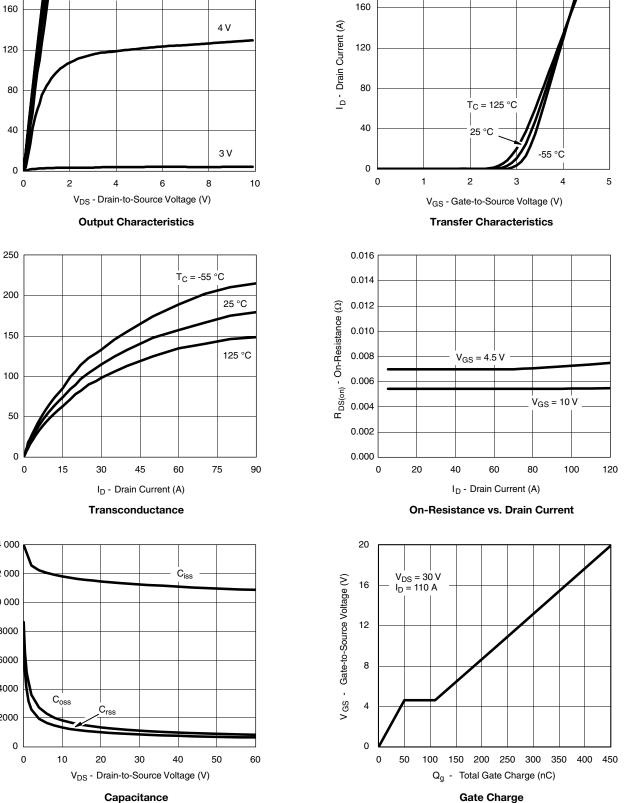
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V_{GS} = 10 V thru 5 V

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I_D - Drain Current (A)



S15-1278-Rev. D, 08-Jun-15

Document Number: 72439

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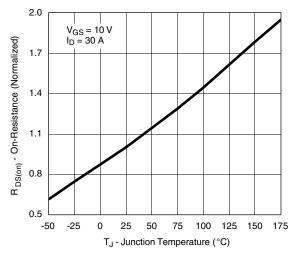
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SUM110P06-07L

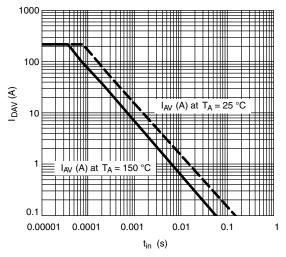
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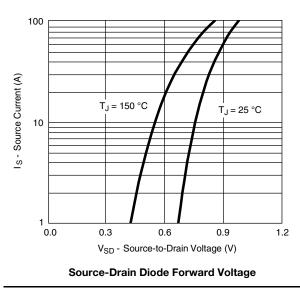
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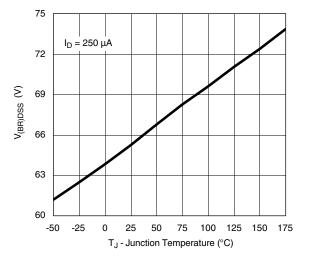


On-Resistance vs. Junction Temperature

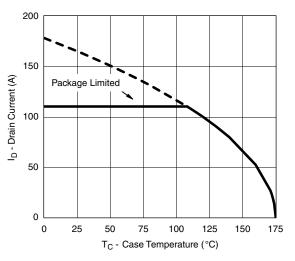




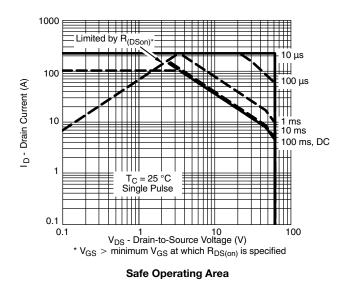




Drain Source Breakdown vs. Junction Temperature



Maximum Avalanche and Drain Current vs. Case Temperature



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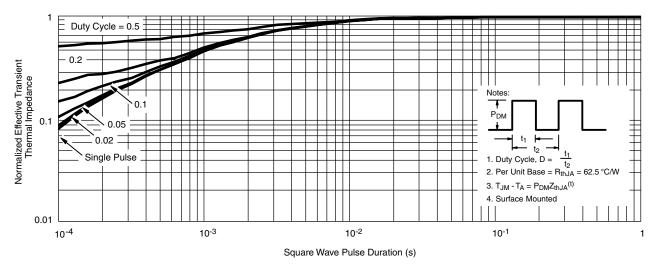
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



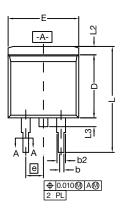
Normalized Thermal Transient Impedance, Junction-to-Case

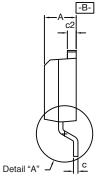
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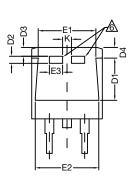


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TO-263 (D²PAK): 3-LEAD

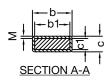








DETAIL A (ROTATED 90°)



		INCHES		MILLIMETERS		
DIM.		MIN.	MAX.	MIN.	MAX.	
A		0.160	0.190	4.064	4.826	
b		0.020	0.039	0.508	0.990	
	b1	0.020	0.035	0.508	0.889	
	b2	0.045	0.055	1.143	1.397	
с*	Thin lead	0.013	0.018	0.330	0.457	
C	Thick lead	0.023	0.028	0.584	0.711	
c1	Thin lead	0.013	0.017	0.330	0.431	
CI	Thick lead	0.023	0.027	0.584	0.685	
	c2	0.045	0.055	1.143	1.397	
	D	0.340	0.380	8.636	9.652	
	D1	0.220	0.240	5.588	6.096	
D2		0.038	0.042	0.965	1.067	
D3		0.045	0.055	1.143	1.397	
	D4	0.044	0.052	1.118	1.321	
	E	0.380	0.410	9.652	10.414	
	E1	0.245	-	6.223	-	
	E2	0.355	0.375	9.017	9.525	
E3		0.072	0.078	1.829	1.981	
	е	0.100 BSC		2.54 BSC		
	К	0.045	0.055	1.143	1.397	
	L	0.575	0.625	14.605	15.875	
L1		0.090	0.110	2.286	2.794	
L2		0.040	0.055	1.016	1.397	
	L3	0.050	0.070	1.270	1.778	
	L4	0.010 BSC		0.254 BSC		
М		-	0.002	-	0.050	
ECN: T13-0707-Rev. K, 30-Sep-13 DWG: 5843						

Notes

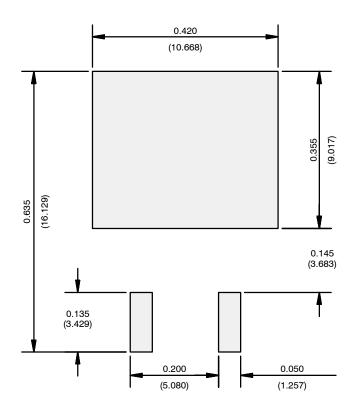
- 1. Plane B includes maximum features of heat sink tab and plastic. 2. No more than 25 $\,\%\,$ of L1 can fall above seating plane by
- max. 8 mils. 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB.
 - Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

This feature is for thick lead.

Revison: 30-Sep-13



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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